

Overview

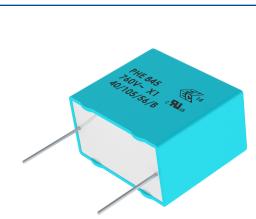
The PHE845 Series is constructed of metallized polypropylene film encapsulated with self-extinguishing resin in a box of material meeting the requirements of UL 94 V-0.

Benefits

- Approvals: ENEC, UL, cUL
- Class X1 (IEC 60384-14)
- Rated Voltage: 760VAC 50/60Hz
- Capacitance range: 0.01 1.0 μF
- Lead spacing: 22.5 37.5 mm
- Capacitance tolerance: ±20%, ±10%
- Climatic category 40/105/56/B, IEC 60068-1
- Tape and reel in accordance with IEC 60286-2
- RoHS Compliant and lead-free terminations
- Operating temperature range of -40°C to +105°C
- 100% screening factory test at 4,250 VDC

Legacy Part Number System

· Self-healing properties



For use as a electromagnetic interference (EMI) suppression

classification. Suitable for use in situations where failure of

filter in across-the-line applications requiring X1 safety

the capacitor would not lead to danger of electric shock.

Applications

PHE845	V	D	5100	Μ	R06L2
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Capacitance Tolerance	Packaging
X1, Metallized Polypropylene	V = 760	D = 22.5 F = 27.5 R = 37.5	The last three digits represent significant figures. The first digit specifies the total number of digits.	K = ±10% M = ±20%	See Ordering Options Table

New KEMET Part Number System

Class(mm)First two digits representK = ±10%760 = 760See OrderF = FilmX1, MetallizedD = 22.5SeeFirst two digits representK = ±10%760 = 760See Order	F	845	D	D	103	Μ	760	С
Polypropylene F = 27.5 Dimension significant figures. Third M = ±20% Options T	•	Series		Size Code	Capacitance Code (pF)	•		Packaging
Zeros.	F = Film	,	F = 27.5	Dimension	significant figures. Third digit specifies number of		760 = 760	See Ordering Options Table

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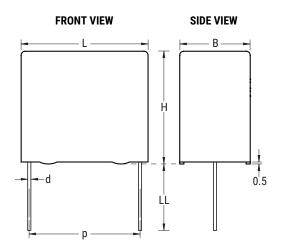
Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	KEMET Lead and Packaging Code	Legacy Lead and Packaging Code
	Standard Lead and Packaging Options			
	Bulk (Tray)-Short Leads	6 +0/-1	С	R06L2 ⁽¹⁾
	Other Lead and Packaging Options			
22.5	Pizza Pack	6 +0/-1	Z	R06L2 ⁽¹⁾
	Bulk (Tray)-Long Leads	30 +0/-1	ALW0L	R30L2
	Tape & Reel (Standard Reel)	H ₀ = 18.5 +/-0.5	L	R17T0
	Tape & Reel (Large Reel)	H ₀ = 18.5 +/-0.5	Р	R17T1
	Standard Lead and Packaging Options			
	Bulk (Tray)–Short Leads	6 +0/-1	С	R06L2 ⁽¹⁾
27.5	Other Lead and Packaging Options			
	Pizza Pack	6 +0/-1	Z	R06L2 ⁽¹⁾
	Bulk (Tray)-Long Leads	30 +0/-1	ALWOL	R30L2
	Tape & Reel (Large Reel)	H ₀ = 18.5 +/-0.5	Р	R17T1
	Standard Lead and Packaging			
	Options			
37.5	Bulk (Tray)–Short Leads	6 +0/-1	С	R06L2 ⁽¹⁾
	Other Lead and Packaging Options			
	Pizza Pack	6 +0/-1	Z	R06L2 ⁽¹⁾

(1) Please specify Bulk (Tray) or Pizza Packaging



Dimensions – Millimeters



KEMET Size	Legacy Size	р	В		I	Н		L	d		
Code	Code	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
DD	D13	22.5	+/- 0.4	6.5	Maximum	14.5	Maximum	26.0	Maximum	0.8	+/- 0.05
DG	D17	22.5	+/- 0.4	7.0	Maximum	16.5	Maximum	26.0	Maximum	0.8	+/- 0.05
DM	D15	22.5	+/- 0.4	9.0	Maximum	18.5	Maximum	26.0	Maximum	0.8	+/- 0.05
DR	D18	22.5	+/- 0.4	10.5	Maximum	19.0	Maximum	26.0	Maximum	0.8	+/- 0.05
DT	D16	22.5	+/- 0.4	11.0	Maximum	21.5	Maximum	26.0	Maximum	0.8	+/- 0.05
DW	D20	22.5	+/- 0.4	13.5	Maximum	23.0	Maximum	26.0	Maximum	0.8	+/- 0.05
DY	D19	22.5	+/- 0.4	15.5	Maximum	24.5	Maximum	26.0	Maximum	0.8	+/- 0.05
FE	F11	27.5	+/- 0.4	10.5	Maximum	20.5	Maximum	31.5	Maximum	0.8	+/- 0.05
FG	F12	27.5	+/- 0.4	11.5	Maximum	22.5	Maximum	31.5	Maximum	0.8	+/- 0.05
FK	F03	27.5	+/- 0.4	13.5	Maximum	23.0	Maximum	31.5	Maximum	0.8	+/- 0.05
FS	F15	27.5	+/- 0.4	19.0	Maximum	29.0	Maximum	31.5	Maximum	0.8	+/- 0.05
FV	F16	27.5	+/- 0.4	21.0	Maximum	30.0	Maximum	31.5	Maximum	0.8	+/- 0.05
RH	R04	37.5	+/- 0.5	15.0	Maximum	26.0	Maximum	41.0	Maximum	1.0	+/- 0.05
RK	R02	37.5	+/- 0.5	16.5	Maximum	32.0	Maximum	41.0	Maximum	1.0	+/- 0.05
RM	R03	37.5	+/- 0.5	19.0	Maximum	36.0	Maximum	41.0	Maximum	1.0	+/- 0.05
RP	R06	37.5	+/- 0.5	21.0	Maximum	38.0	Maximum	41.0	Maximum	1.0	+/- 0.05
		Not	e: See Order	ing Options	Table for lea	d length (Ll	.) options.				



Performance Characteristics

Dielectric	Polypropylene film					
Plates	Metal layer deposited by	evaporation under vacuum				
Winding	Non-inductive type. Triple	e design.				
Leads	Tinned wire					
Protection	Plastic case, thermosetting	ı resin filled. Box material is so	olvent resistant and flame retain	ardant according to UL94.		
Rated Voltage (V _R)	760 VAC 50/60 Hz					
Capacitance Range	0.010 μF to 1.0 μF					
Capacitance Values	E6 series (IEC 60063)					
Capacitance Tolerance	±20% standard, ±10% opti	ion				
Temperature Range	-40°C to 105°C					
Climatic Category	40/105/56/B IEC 60068-1					
Approvals	ENEC, UL, cUL					
Related Documents	EN/IEC 60384-14:2005, U	L 60384-14, CAN/CSA E603	84-14:09			
Dissipation Factor (tanδ)		Maximum Val	lues at +23°C			
	Frequency	C ≤ 0.1 µF	0.1 µF < C ≤ 1 µF			
Dissipation Factor (tan δ)	1 kHz	0.1%	0.1%			
Dissipation Factor (tanδ)	1 kHz 10 kHz	0.1%	0.1%			
Dissipation Factor (tanδ)	10 kHz 100 kHz	0.2%	0.4%			
Dissipation Factor (tanδ) Test Voltage Between Terminals	10 kHz 100 kHz The 100% screening factor requirements in applicable	0.2%	0.4% - VDC. The voltage level is selectrical characteristics are c	hecked after the test. It is		
	10 kHz 100 kHz The 100% screening factor requirements in applicable not permitted to repeat this for any failures.	0.2% 0.6% ry test is carried out at 4,250 e equipment standards. All ele	0.4% - VDC. The voltage level is sel ectrical characteristics are c nage the capacitor. KEMET is	hecked after the test. It is s not liable in such case		
Test Voltage Between Terminals	10 kHz 100 kHz The 100% screening factor requirements in applicable not permitted to repeat this for any failures.	0.2% 0.6% ry test is carried out at 4,250 e equipment standards. All ele s test as there is a risk to dan	0.4% - VDC. The voltage level is sel ectrical characteristics are c nage the capacitor. KEMET is - Ratings & Part Number Re	hecked after the test. It is s not liable in such case		
Test Voltage Between Terminals Resonance Frequency	10 kHz 100 kHz The 100% screening factor requirements in applicable not permitted to repeat this for any failures.	0.2% 0.6% ry test is carried out at 4,250 e equipment standards. All ele s test as there is a risk to dan e frequencies f _o (see Table 1	0.4% - VDC. The voltage level is selectrical characteristics are cl nage the capacitor. KEMET is - Ratings & Part Number Re according to IEC 60384-2	hecked after the test. It is s not liable in such case		
Test Voltage Between Terminals	10 kHz 100 kHz The 100% screening factor requirements in applicable not permitted to repeat this for any failures.	0.2% 0.6% ry test is carried out at 4,250 equipment standards. All ele s test as there is a risk to dan frequencies f _o (see Table 1 Measured at +25°C ±5°C, a Minimum Values B	0.4% - VDC. The voltage level is selectrical characteristics are clinage the capacitor. KEMET is - Ratings & Part Number Re according to IEC 60384-2 Between Terminals	hecked after the test. It is s not liable in such case		
Test Voltage Between Terminals Resonance Frequency	10 kHz 100 kHz The 100% screening factor requirements in applicable not permitted to repeat this for any failures. Tabulated self-resonance	0.2% 0.6% Ty test is carried out at 4,250 e equipment standards. All ele s test as there is a risk to dan e frequencies f _o (see Table 1 Measured at +25°C ±5°C, a Minimum Values B 33 μF	0.4% - VDC. The voltage level is selectrical characteristics are conage the capacitor. KEMET is - Ratings & Part Number Re according to IEC 60384–2 etween Terminals C > 0.	hecked after the test. It is s not liable in such case eference)		



Environmental Test Data

Test	IEC Publication	Procedure
Endurance	IEC 60384-14:2005	1.25 x V _R VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 – 55 Hz at 0.75 mm or 98 m/s ² No visible damage. No open or short circuit.
Bump	IEC 60068-2-29 Test Eb	1,000 bumps at 390 m/s ² No visible damage. No open or short circuit.
Change of Temperature	IEC 60068-2-14 Test Na	Upper and lower rated temperature 5 cycles No visible damage.
Active Flammability	IEC 60384-14:2005	V_{R} + 20 surge pulses at 4 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384-14:2005	IEC 60384-1, IEC 60695-11-5 Needle Flame Test
Damp Heat Steady State	IEC 60068-2-78 Test Cab	+40°C and 90 – 95% RH, 56 days

Approvals

Certification Body	Mark	Specification	File Number
Intertek Semko AB		EN/IEC 60384-14	SE/0140-17D
UL	c FL us	UL 60384 and CAN/CSA E60384-14:09 (760 VAC)	E73869

Environmental Compliance

All KEMET EMI capacitors are RoHS Compliant.



Table 1 – Ratings & Part Number Reference

Capacitance Value (µF)	Size Code (New/		laximu 1sions i		Lead Spacing (p)	f _。 (MHz)	dV/dt (V/	New KEMET Part Number	Legacy Part Number
value (µr)	Legacy)	В	Н	L	opuonig (p)	(µs)	i art italiibei	Humber
0.010	DD/D13	6.5	14.5	26.0	22.5	11	100	F845DD103(1)760(2)	PHE845VD5100(1)(2)
0.015	DD/D13	6.5	14.5	26.0	22.5	9.2	100	F845DD153(1)760(2)	PHE845VD5150(1)(2)
0.022	DD/D13	6.5	14.5	26.0	22.5	7.6	100	F845DD223(1)760(2)	PHE845VD5220(1)(2)
0.033	DF/D17	7.0	16.5	26.0	22.5	6.4	100	F845DF333(1)760(2)	PHE845VD5330(1)(2)
0.047	DM/D15	9.0	18.5	26.0	22.5	5.3	100	F845DM473(1)760(2)	PHE845VD5470(1)(2)
0.068	DR/D18	10.5	19.0	26.0	22.5	4.4	100	F845DR683(1)760(2)	PHE845VD5680(1)(2)
0.10	DT/D16	11.0	21.5	26.0	22.5	3.5	100	F845DT104(1)760(2)	PHE845VD6100(1)(2)
0.15	DW/D20	13.5	23.0	26.0	22.5	3.1	100	F845DW154(1)760(2)	PHE845VD6150(1)(2)
0.22	DY/D19	15.5	24.5	26.0	22.5	2.7	100	F845DY224M760(2)	PHE845VY6220M(2)
0.10	FE/F11	10.5	20.5	31.5	27.5	3.4	100	F845FE104(1)760(2)	PHE845VF6100(1)(2)
0.15	FG/F12	11.5	22.5	31.5	27.5	3.0	100	F845FG154(1)760(2)	PHE845VF6150(1)(2)
0.22	FK/F03	13.5	23.0	31.5	27.5	2.4	100	F845FK224(1)760(2)	PHE845VF6220(1)(2)
0.33	FS/F15	19.0	29.0	31.5	27.5	2.0	100	F845FS334(1)760(2)	PHE845VF6330(1)(2)
0.47	FV/F16	21.0	30.0	31.5	27.5	1.6	100	F845FV474M760(2)	PHE845VZ6470M(2)
0.47	RH/R04	15.0	26.0	41.0	37.5	1.6	100	F845RH474M760(2)	PHE845VW6470M(2)
0.47	RK/R02	16.5	32.0	41.0	37.5	1.6	100	F845RK474(1)760(2)	PHE845VR6470(1)(2)
0.68	RM/R03	19.0	36.0	41.0	37.5	1.2	100	F845RM684(1)760(2)	PHE845VR6680(1)(2)
1.0	RP/R06	21.0	38.0	41.0	37.5	1.0	100	F845RP105M760(2)	PHE845VW7100M(2)
Capacitance Value (µF)	Size Code (New/ Legacy)	B (mm)	H (mm)	L (mm)	Lead Spacing (p)	f _。 (MHz)	dV/dt (V/µs)	New KEMET Part Number	Legacy Part Number

(1) $M = \pm 20\%$, $K = \pm 10\%$.

(2) Insert ordering code for lead type and packaging. See Ordering Options Table for available options.



Soldering Process

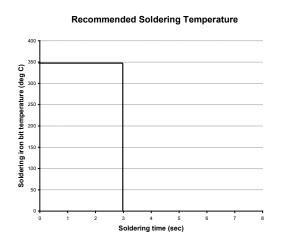
The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 mm to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

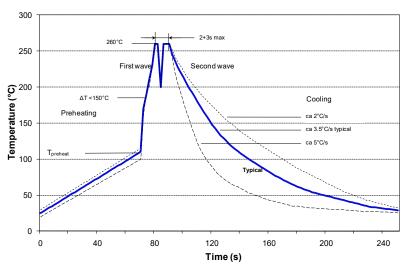
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont'd

Wave Soldering Recommendations cont'd

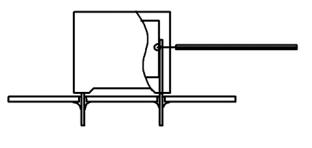
1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric		imum Pre emperatu		Peak So	mum oldering erature
Film Material	Capacitor Pitch ≤ 10 mm	Capacitor Pitch = 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm
Polyester	130°C	130°C	130°C	270°C	270°C
Polypropylene	100°C	110°C	130°C	260°C	270°C
Paper	130°C	130°C	140°C	270°C	270°C
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C

2. The maximum temperature measured inside the capacitor:

Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene sulphide	160°C



Temperature monitored inside the capacitor.

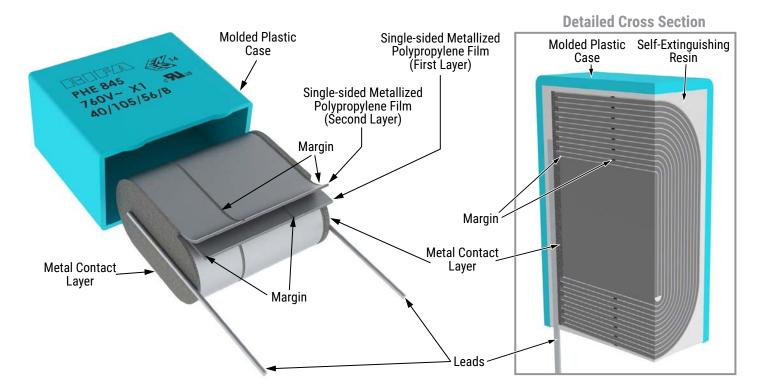
Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

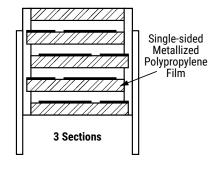
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, **however, instead of two baths, there is only one bath with a time from 3 to 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.



Construction

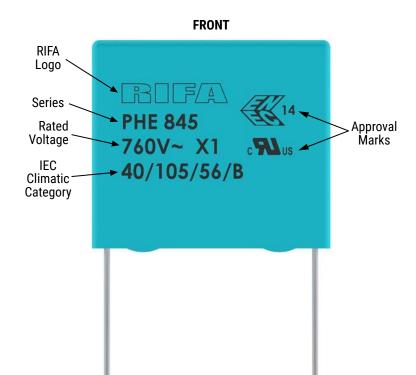


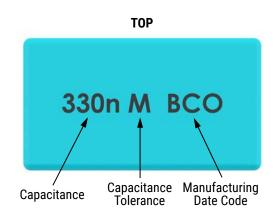
Winding Scheme





Marking





Mai	nufacturing Da	te Code (IEC 6006	52)							
	Y = Year, Z = Month									
Year	Code	Month	Code							
2000	М	January	1							
2001	N	February	2							
2002	Р	March	3							
2003	R	April	4							
2004	S	May	5							
2005	Т	June	6							
2006	U	July	7							
2007	V	August	8							
2008	W	September	9							
2009	Х	October	0							
2010	Α	November	N							
2011	В	December	D							
2012	C									
2013	D									
2014	E									
2015	F									
2016	Н									
2017	J									
2018	K									
2019	L									
2020	М									

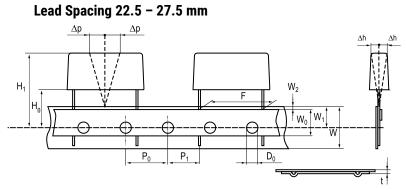


Packaging Quantities

KEMET Size Code	Legacy Size Code	Lead Spacing	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Standard Reel ø 360 mm	Large Reel ø 500 mm	Ammo Bulk (Pizza)
DD	D13		6.5	14.5	26.0	234	300	600	440
DH	D14		8.0	16.0	26.0	186	250	500	352
DM	D15	-	9.0	18.5	26.0	308	250	500	308
DT	D16	22.5	11.0	21.5	26.0	253	200	400	253
DF	D17	22.3	7.0	16.5	26.0	216	300	600	396
DR	D18		10.5	19.0	26.0	264	200	400	264
DY	D19		15.5	24.5	26.0	176	110	250	176
DW	D20		13.5	23.0	26.0	209	160	300	209
FK	F03		13.5	23.0	31.5	171		250	171
FE	F11	-	10.5	20.5	31.5	216		350	216
FG	F12		11.5	22.5	31.5	198		300	198
FM	F13		14.5	24.5	31.5	153		250	153
FR	F14	07 5	17.5	28.0	31.5	126			126
FS	F15	27.5	19.0	29.0	31.5	117			117
FV	F16		21.0	30.0	31.5	108			108
FH	F17		21.0	12.5	31.5	108			108
FT	F18		31.0	18.5	31.5	72			72
FQ	F19		27.5	16.0	31.5	81			81
RK	R02		16.5	32.0	41.0	105			105
RM	R02		19.0	36.0	41.0	91			91
RH	R03		15.0	26.0	41.0	119			119
RF	R04	37.5	13.0	24.0	41.0	140			140
RP	R06		21.0	38.0	41.0	84			84
RS	R08		28.0	43.0	41.0	54			54



Lead Taping & Packaging (IEC 60286-2)



Taping Specification

Description	Symbol	Dimensions (mm)		
		Lead Space		Tolerance
		22.5	27.5	TOTELATICE
Lead spacing	F	22.5	27.5	+0.6/-0.1
Carrier tape width	W	18	18	+1/-0.5
Hold down tape width	W _o	10	10	Minimum
Hole position	W ₁	9	9	+ 0.75/-0.5
Hold down tape position	W ₂	3	3	Maximum
Feed hole diameter	D ₀	4	4	± 0.2
Feed hole lead space*	P ₀	12.7	12.7	± 0.2**
Centering of the lead wire	P ₁	7.8	5.3	± 0.7
Component alignment	Δh	2	2	± 2
Deviation tape – plane	Δp	1.3	1.3	Maximum
Tape thickness	t	0.9	0.9	Maximum
Height of component from tape center	H ₀ ***	18.5	18.5	± 0.5

*Available also 15mm.

**Maximum 1 mm on 20 lead spaces.

*** H_0 = 16.5 mm is available upon request.



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Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.

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